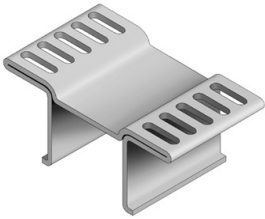


Data sheet Product FK 244 13 D PAK



Board Level heatsinks>Heatsinks for D PAK and others

- direct PCB mounting thru solderable surface
- available standard packing: loose parts (**bulk goods**) or reel (TR = tape and reel)
- **tape width:** 44 mm, **reel diameter:** 330 mm, **quantity:** FK 244 08 = 450, FK 244 13 = 200

Features

for transistor:

- SOT 223
- D³ PAK (TO 268)
- SO-14
- D² PAK (TO 263)
- Power SO 10
- D PAK (TO 252)
- SO-16
- SO-8

width: 23 mm

height: 10 mm

length: 13 mm

thermal resistance: 25 K/W

surface: solderable surface

material: copper (Cu)

material thickness: 0.6 mm

Technical Drawing

